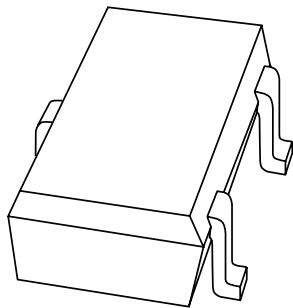


DATA SHEET



2PD1820A

NPN general purpose transistor

Product data sheet
Supersedes data of 1997 May 22

1999 Apr 12

NPN general purpose transistor

2PD1820A

FEATURES

- High current (max. 500 mA)
- Low voltage (max. 50 V)
- Low collector-emitter saturation voltage (max. 600 mV).

APPLICATIONS

- General purpose switching and amplification, especially for portable equipment.

DESCRIPTION

NPN transistor in an SC-70; SOT323 plastic package.
PNP complement: 2PB1219A.

MARKING

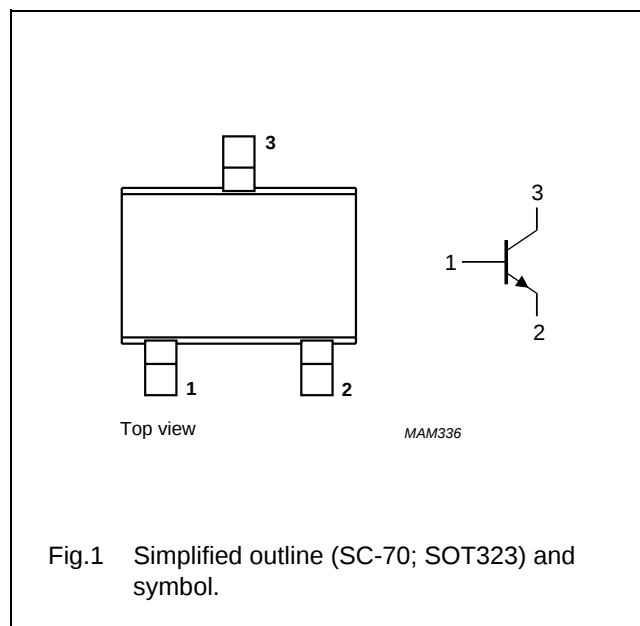
TYPE NUMBER	MARKING CODE ⁽¹⁾
2PD1820AQ	A*Q
2PD1820AR	A*R
2PD1820AS	A*S

Note

- * = - : Made in Hong Kong.
* = t : Made in Malaysia.

PINNING

PIN	DESCRIPTION
1	base
2	emitter
3	collector



LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{CBO}	collector-base voltage	open emitter	–	60	V
V_{CEO}	collector-emitter voltage	open base	–	50	V
V_{EBO}	emitter-base voltage	open collector	–	5	V
I_C	collector current (DC)		–	500	mA
I_{CM}	peak collector current		–	1	A
I_{BM}	peak base current		–	200	mA
P_{tot}	total power dissipation	$T_{amb} \leq 25\text{ °C}$; note 1	–	200	mW
T_{stg}	storage temperature		–65	+150	°C
T_j	junction temperature		–	150	°C
T_{amb}	operating ambient temperature		–65	+150	°C

Note

1. Transistor mounted on an FR4 printed-circuit board.

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THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
$R_{th\ j-a}$	thermal resistance from junction to ambient	note 1	625	K/W

Note

1. Transistor mounted on an FR4 printed-circuit board.

CHARACTERISTICS

$T_{amb} = 25\text{ °C}$ unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
I_{CBO}	collector cut-off current	$I_E = 0$; $V_{CB} = 20\text{ V}$	–	10	nA
		$I_E = 0$; $V_{CB} = 20\text{ V}$; $T_j = 150\text{ °C}$	–	5	μA
I_{EBO}	emitter cut-off current	$I_C = 0$; $V_{EB} = 4\text{ V}$	–	10	nA
h_{FE}	DC current gain 2PD1820AQ 2PD1820AR 2PD1820AS	$I_C = 150\text{ mA}$; $V_{CE} = 10\text{ V}$; note 1	85	170	
			120	240	
			170	340	
h_{FE}	DC current gain	$I_C = 500\text{ mA}$; $V_{CE} = 10\text{ V}$; note 1	40	–	
V_{CEsat}	collector-emitter saturation voltage	$I_C = 300\text{ mA}$; $I_B = 30\text{ mA}$; note 1	–	600	mV
C_c	collector capacitance	$I_E = i_e = 0$; $V_{CB} = 10\text{ V}$; $f = 1\text{ MHz}$	–	15	pF
f_T	transition frequency	$I_C = 50\text{ mA}$; $V_{CE} = 10\text{ V}$; $f = 100\text{ MHz}$; note 1	150	–	MHz

Note

1. Pulse test: $t_p \leq 300\text{ }\mu\text{s}$; $\delta \leq 0.02$.

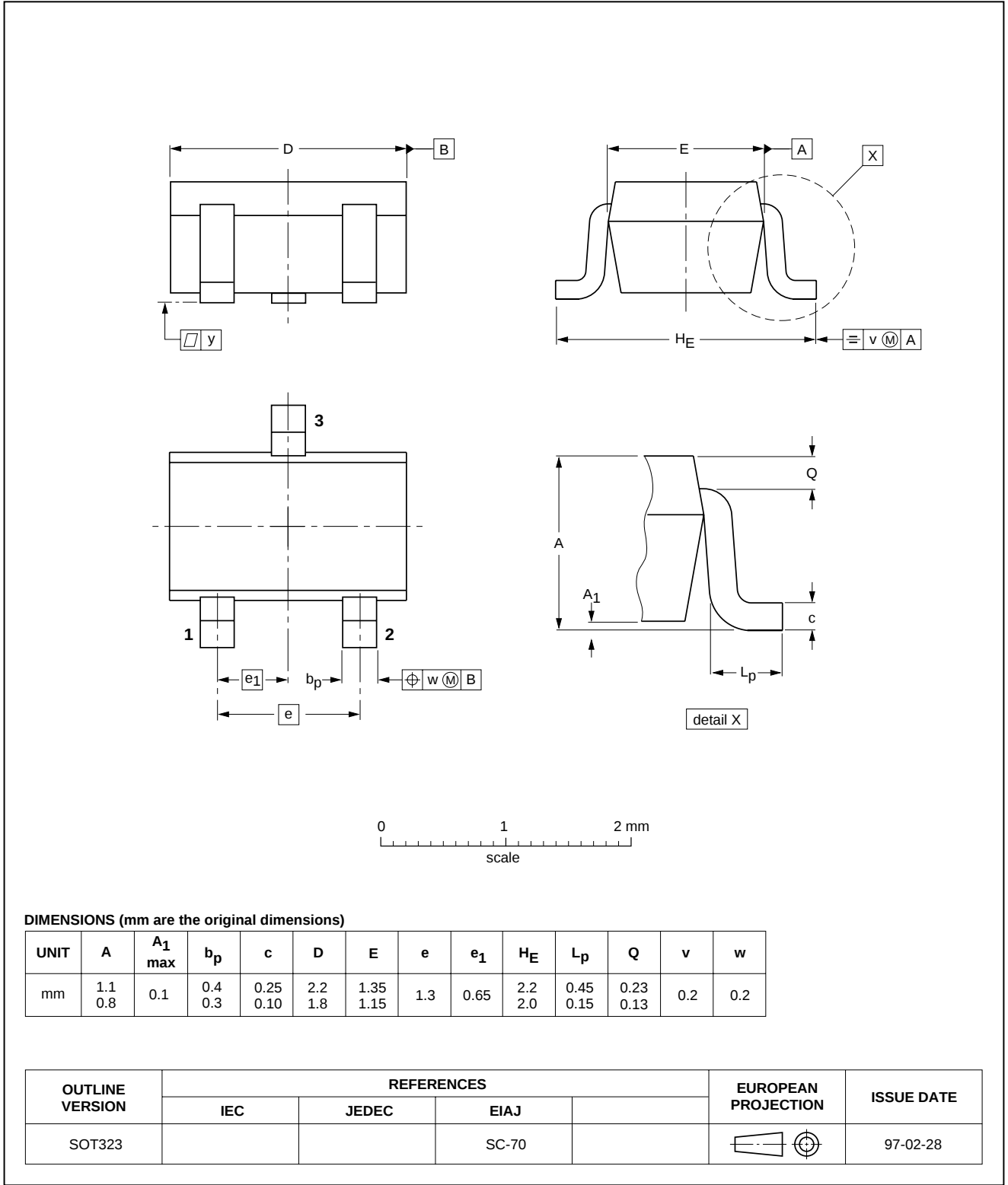
NPN general purpose transistor

2PD1820A

PACKAGE OUTLINE

Plastic surface mounted package; 3 leads

SOT323



NPN general purpose transistor**2PD1820A****DATA SHEET STATUS**

DOCUMENT STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

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2. The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.nxp.com>.

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